

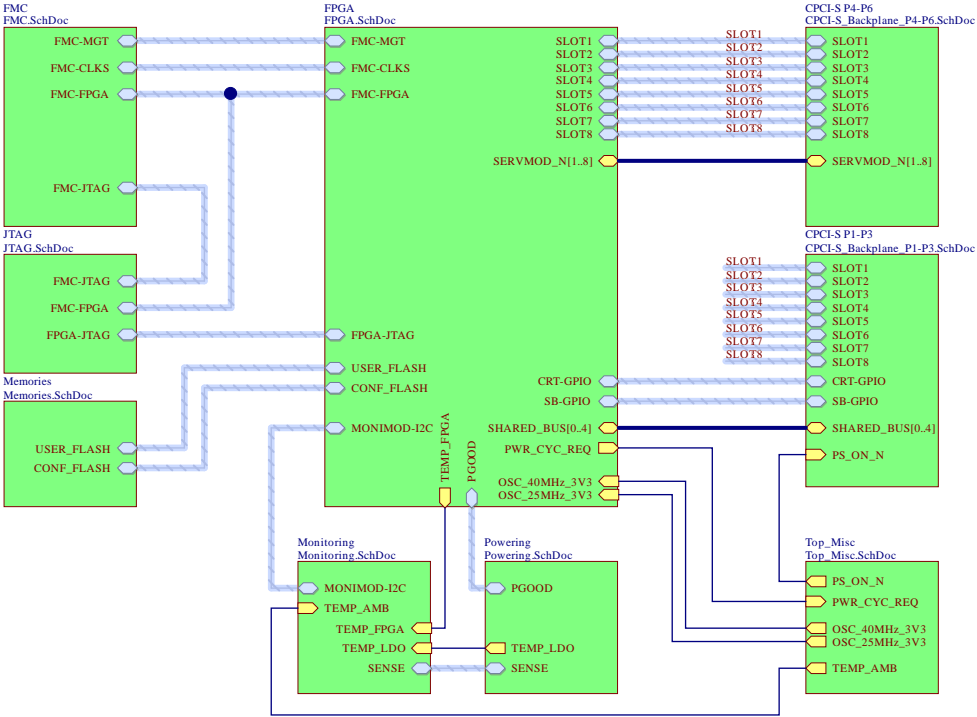
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Project/Equipment		DI/OT	
Document		Designer	C. Gentsos
		Drawn by	C. Gentsos
		Check by	*
		Last Mod.	C. Gentsos
		File	DIOT-sb-ig1_top.SchDoc
		Print Date	28/09/2020 12:23:24
		Sheet	1 of 17
		Size	A3
		Rev	*

DI/OT Rad-tol System Board
Top Level

European Organization for Nuclear Research
CH-1211 Genève 23 - Switzerland

EDA-XXXXX-VX-X

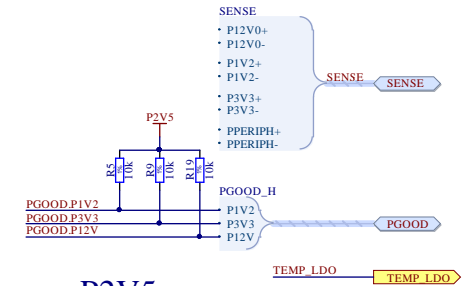
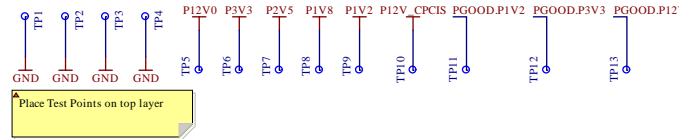
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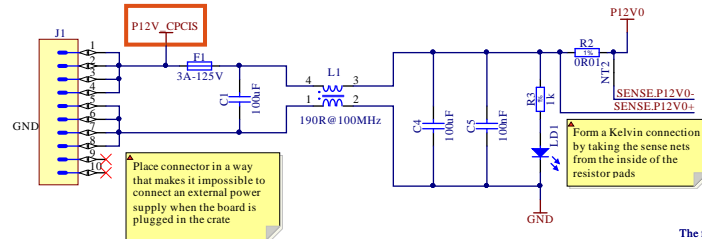
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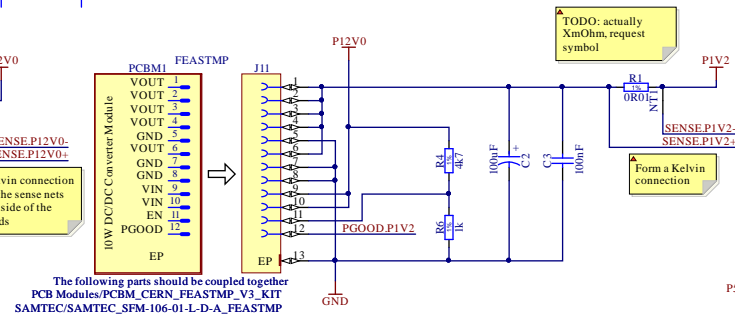
Test points



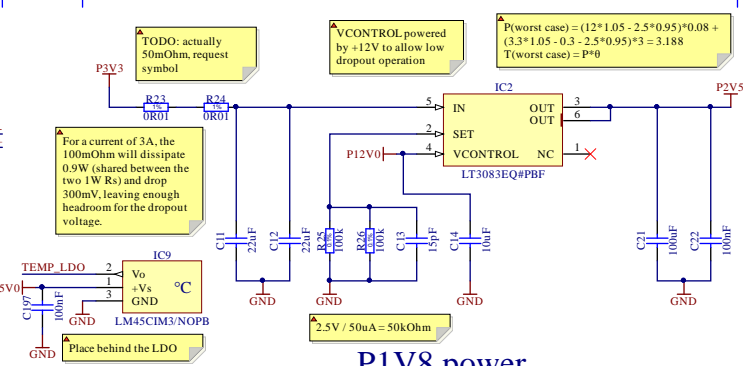
12V0 power cleanup



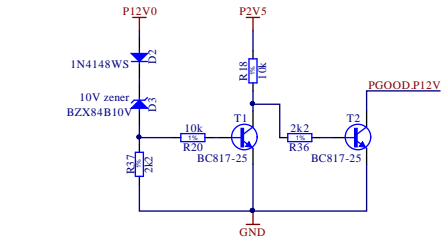
P1V2 power



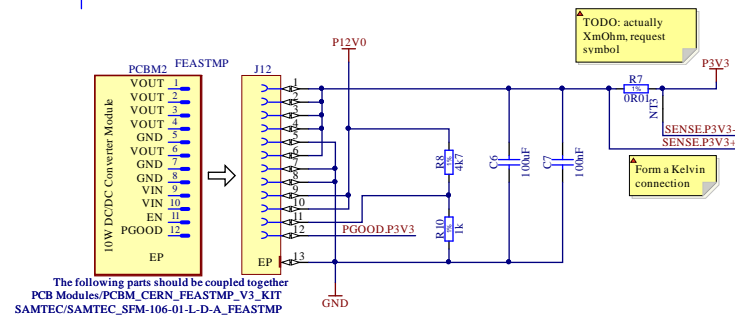
P2V5 power



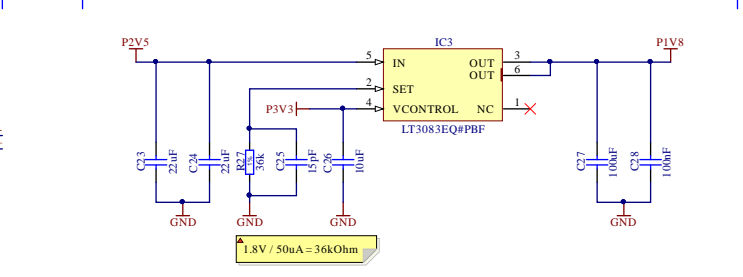
12V brownout detection



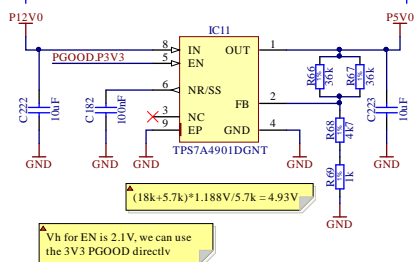
P3V3 power



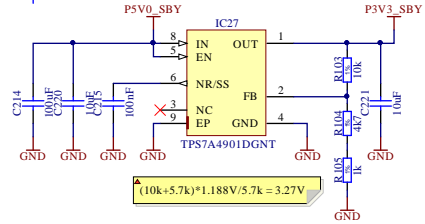
P1V8 power



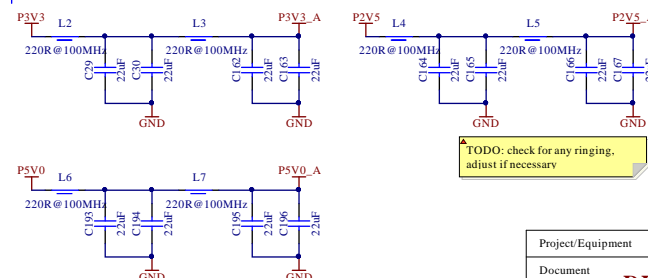
P5V0 power



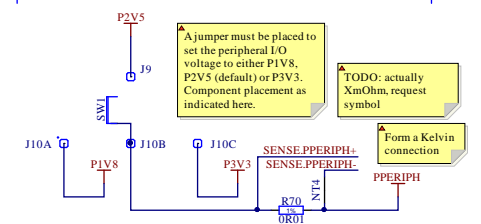
Always-on P3V3 power



Analog power filtering



Peripheral voltage selection



Project/Equipment	DIOT	Designer	C. Gentsos	28/08/2020
Document		Drawn by	C. Gentsos	28/08/2020
BE/CO		Check by	*	28/09/2020
		Last Mod.	C. Gentsos	28/09/2020
		File	Powering_SchDoc	
		Print Date	28/09/2020 12:23:24	Sheet 2 of 17
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DIOT Rad-tol System Board Power

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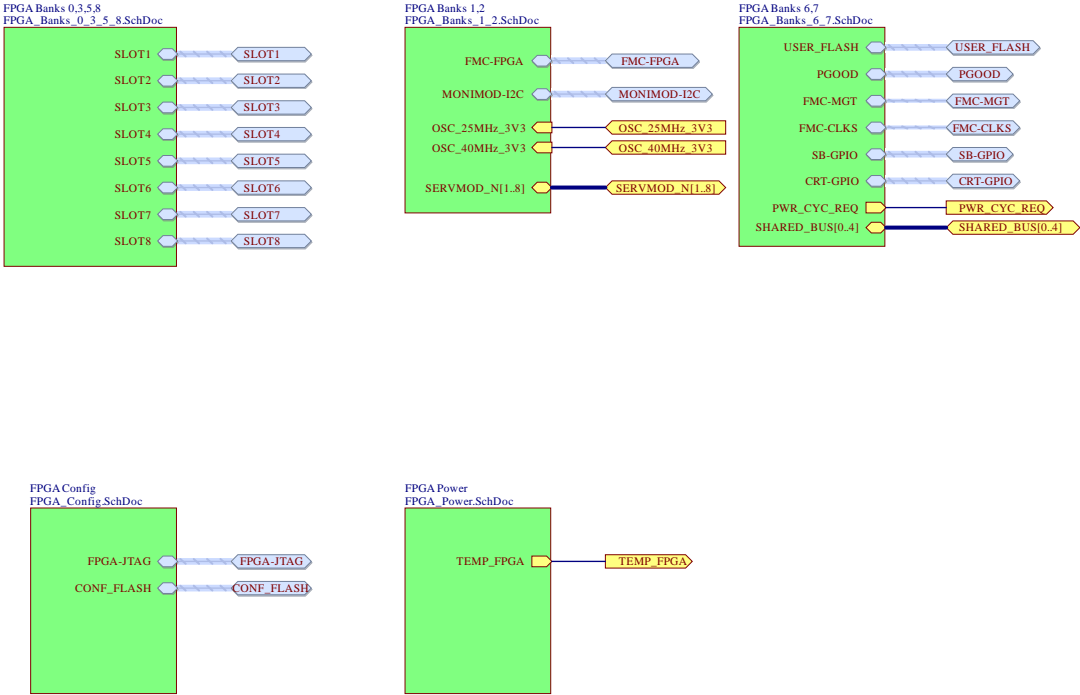
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		Check by	*
		Last Mod.	C. Gentsos
		File	FPGA.SchDoc
		Print Date	28/09/2020 12:23:25
		Sheet	3 of 17
		Size	A3
		Rev	*

BE/CO

DI/OT Rad-tol System Board

FPGA Top

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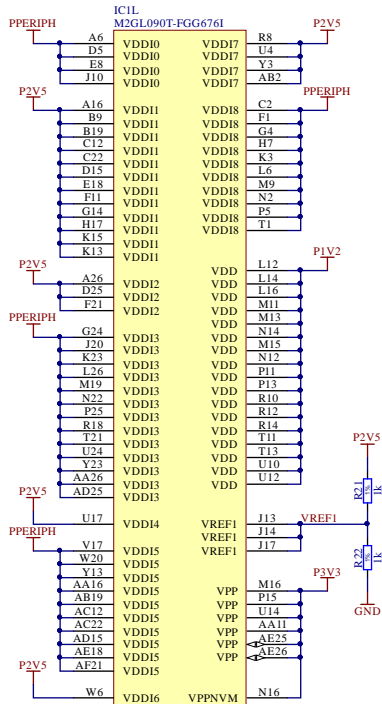
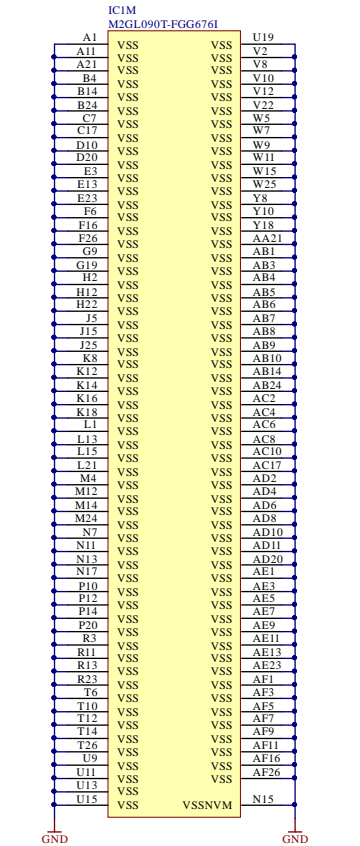
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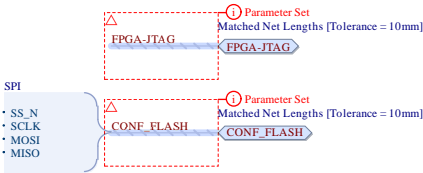
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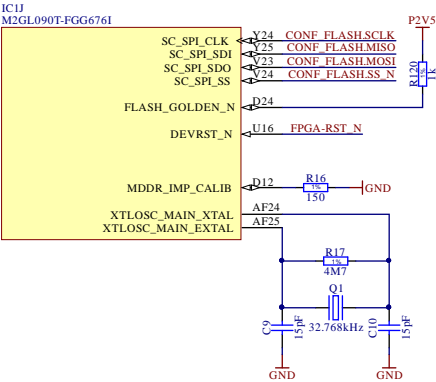
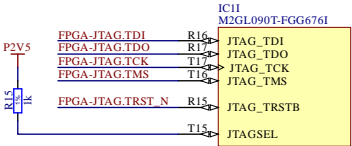
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Parts powered by 2.5V

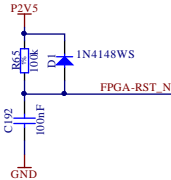


The JTAG and configuration pins are referred to as Bank 4



TODO: calibration not required so 0R may be acceptable, to be clarified.

This is to trigger a reprogram from the flash, assuming that



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		File	FPGA_Config.SchDoc
		Print Date	28/09/2020 12:23:27
		Sheet	5 of 17
		Size	A3
		Rev	*

BE/CO

DI/OT Rad-tol System Board
FPGA Configuration

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Banks powered by 2.5V

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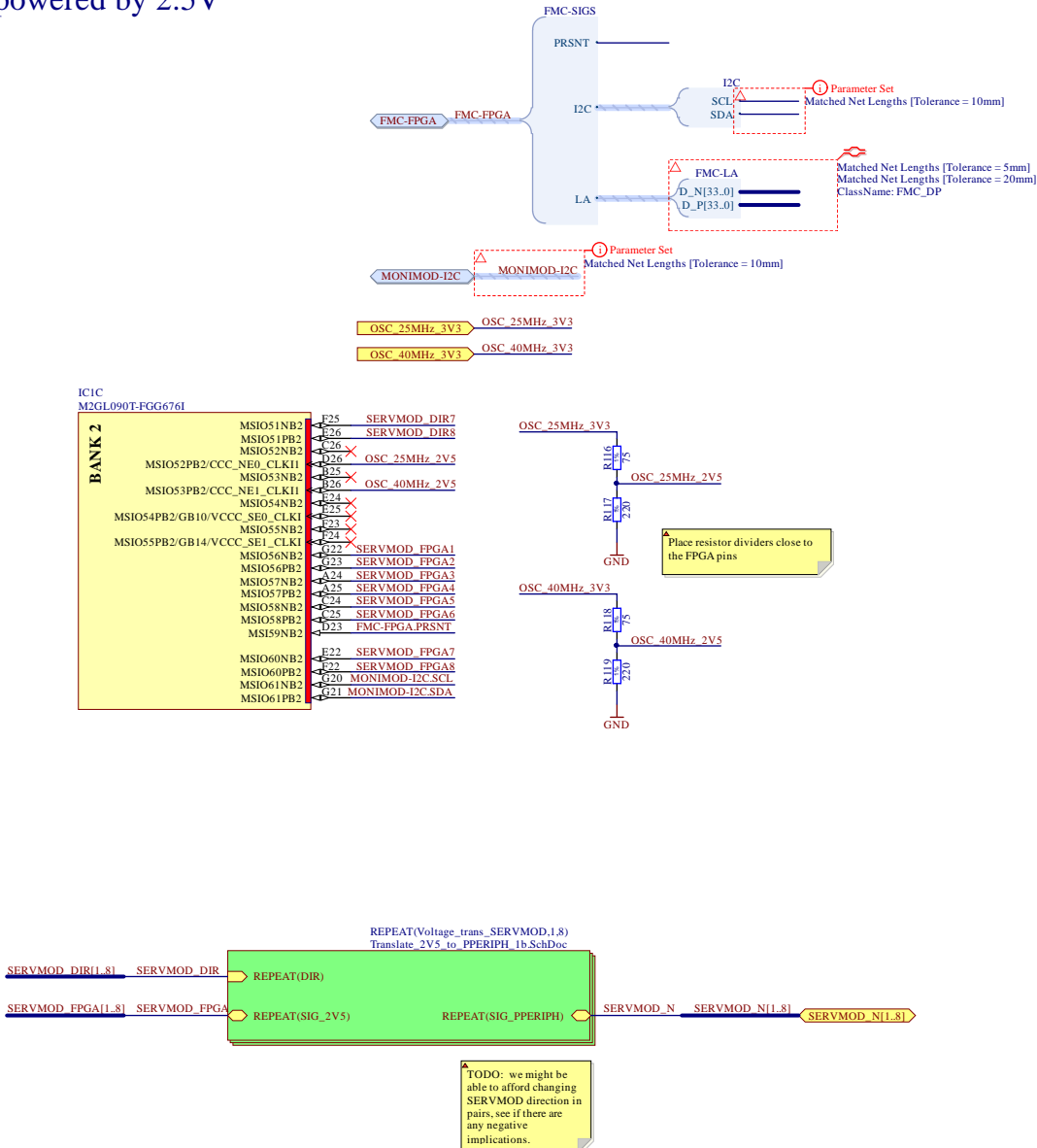
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IC1B
M2GL090T-FGG6761

BANK 1	DDRIO62NB1/MDDR_ADDR15	C23	FMC-FPGA.L.A.D_N14
	DDRIO62PB1/MDDR_ADDR14	C22	FMC-FPGA.L.A.D_P14
	DDRIO63NB1/MDDR_ADDR15	C23	FMC-FPGA.L.A.D_N15
	DDRIO63PB1/MDDR_ADDR12	C23	FMC-FPGA.L.A.D_P15
	DDRIO64NB1/MDDR_ADDR11	C21	FMC-FPGA.L.A.D_N2
	DDRIO64PB1/MDDR_ADDR10	C20	FMC-FPGA.L.A.D_N3
	DDRIO65NB1/MDDR_ADDR9	C20	FMC-FPGA.L.A.D_P3
	DDRIO65PB1/MDDR_ADDR8	C22	FMC-FPGA.L.A.D_N4
	DDRIO66NB1/MDDR_ADDR7	C22	FMC-FPGA.L.A.D_P4
	DDRIO67NB1/MDDR_ADDR6	C18	FMC-FPGA.L.A.D_N5
	DDRIO67PB1/MDDR_ADDR5	C18	FMC-FPGA.L.A.D_P5
	DDRIO68NB1/MDDR_ADDR4	C21	FMC-FPGA.L.A.D_N6
	DDRIO68PB1/MDDR_ADDR3	C21	FMC-FPGA.L.A.D_P6
	DDRIO69NB1/MDDR_ADDR2	C19	FMC-FPGA.L.A.D_N7
	DDRIO69PB1/MDDR_ADDR1	C19	FMC-FPGA.L.A.D_P7
	DDRIO70NB1/MDDR_ADDR0	C18	FMC-FPGA.L.A.D_N8
	DDRIO70PB1/MDDR_BA2	C17	FMC-FPGA.L.A.D_P8
	DDRIO71NB1/MDDR_BA1	C20	FMC-FPGA.L.A.D_N9
	DDRIO71PB1/MDDR_BA0	C20	FMC-FPGA.L.A.D_P9
	DDRIO72NB1/MDDR_CLK_N	C20	FMC-FPGA.L.A.D_N10
	DDRIO72PB1/MDDR_CLK_N	C19	FMC-FPGA.L.A.D_P10
	DDRIO73NB1/MDDR_CAS_N	C19	FMC-FPGA.L.A.D_N11
	DDRIO73PB1/MDDR_RESET_N	C18	FMC-FPGA.L.A.D_P11
	DDRIO74NB1/MDDR_CS_N	C17	FMC-FPGA.L.A.D_N12
	DDRIO74PB1/MDDR_CKE	C16	FMC-FPGA.L.A.D_P12
	DDRIO75NB1/MDDR_WE_N	C16	FMC-FPGA.L.A.D_N13
	DDRIO75PB1/MDDR_RAS_N	C16	FMC-FPGA.L.A.D_P13
	DDRIO76NB1/MDDR_DQ15	C19	FMC-FPGA.L.A.D_N1
	DDRIO76PB1/CCC_NE1_CLK13/MDDR_DQ14	C18	FMC-FPGA.L.A.D_P1
	DDRIO77NB1/MDDR_DQ13	C18	FMC-FPGA.L.A.D_N6
	DDRIO77PB1/MDDR_DQ12/GB12/CCC_NE1_CLK12	C18	FMC-FPGA.L.A.D_P0
	DDRIO78NB1/MDDR_DM_RDQS1	C15	FMC-FPGA.L.A.D_N16
	DDRIO78PB1/MDDR_TMATCH_0_IN	C16	FMC-FPGA.L.A.D_P16
	DDRIO79NB1/MDDR_DQS1_N	C17	FMC-FPGA.L.A.D_N17
	DDRIO79PB1/MDDR_DQS1/GB8/CCC_NE0_CLK13	C17	FMC-FPGA.L.A.D_P17
	DDRIO80NB1/MDDR_DQ11	C17	FMC-FPGA.L.A.D_N18
	DDRIO80PB1/MDDR_DQ10/CCC_NE0_CLK12	C16	FMC-FPGA.L.A.D_P18
	DDRIO81NB1/MDDR_DQ9	C16	FMC-FPGA.L.A.D_N19
	DDRIO81PB1/MDDR_DQ8	C16	FMC-FPGA.L.A.D_P19
	DDRIO82NB1/MDDR_TMATCH_0_OUT	C15	FMC-FPGA.L.A.D_N20
	DDRIO82PB1/MDDR_DQ7	C15	FMC-FPGA.L.A.D_P20
	DDRIO83NB1/MDDR_DQ6	C16	FMC-FPGA.L.A.D_N21
	DDRIO83PB1/MDDR_DQ5	C15	FMC-FPGA.L.A.D_P21
	DDRIO84NB1/MDDR_DQ4	C15	FMC-FPGA.L.A.D_N22
	DDRIO84PB1/MDDR_DM_RDQS0	C14	FMC-FPGA.L.A.D_P22
	DDRIO85NB1/MDDR_DQS0_N	C15	FMC-FPGA.L.A.D_N23
	DDRIO85PB1/MDDR_DQS0	C14	FMC-FPGA.L.A.D_P23
	DDRIO86NB1/MDDR_DQ3	C14	FMC-FPGA.L.A.D_N24
	DDRIO86PB1/MDDR_DQ2	C14	FMC-FPGA.L.A.D_P24
	DDRIO87NB1/MDDR_DQ1	C15	FMC-FPGA.L.A.D_N25
	DDRIO87PB1/MDDR_DQ0	C14	FMC-FPGA.L.A.D_P25
	DDRIO88NB1	C13	FMC-FPGA.L.A.D_N26
	DDRIO88PB1/CCC_NW1_CLK13	C13	FMC-FPGA.L.A.D_P26
	DDRIO89NB1/MDDR_DQ_ECC0	C13	FMC-FPGA.L.A.D_N27
	DDRIO89PB1/MDDR_DQ_ECC1	C13	FMC-FPGA.L.A.D_P27
	DDRIO90NB1/MDDR_DM_RDQS_ECC	C13	FMC-FPGA.L.A.D_N28
	DDRIO90PB1/MDDR_TMATCH_ECC_IN	C12	FMC-FPGA.L.A.D_P28
	DDRIO91NB1/MDDR_DQS_ECC_N	C12	FMC-FPGA.L.A.D_N29
	DDRIO91PB1/MDDR_DQS_ECC	C12	FMC-FPGA.L.A.D_P29
	DDRIO92NB1/GB4/CCC_NW1_CLK12	C12	FMC-FPGA.L.A.D_N30
	DDRIO92PB1/GB0/CCC_NW0_CLK13	C12	FMC-FPGA.L.A.D_P30
	DDRIO93NB1/CCC_NW0_CLK12	C14	FMC-FPGA.L.A.D_N31
	DDRIO93PB1/MDDR_TMATCH_ECC_OUT	C14	FMC-FPGA.L.A.D_P31
	DDRIO94NB1	C11	FMC-FPGA.L.A.D_N32
	DDRIO94PB1	C11	FMC-FPGA.L.A.D_P32
	DDRIO95NB1	C11	FMC-FPGA.L.A.D_N33
	DDRIO95PB1	C11	FMC-FPGA.L.A.D_P33
	DDRIO96NB1	C10	FMC-FPGA.L.A.D_N34
	DDRIO96PB1	C10	FMC-FPGA.L.A.D_P34
	DDRIO97NB1	C12	SERVMOD_DIR1
	DDRIO97PB1	C11	SERVMOD_DIR2
	DDRIO98NB1	C9	SERVMOD_DIR3
	DDRIO98PB1	C10	SERVMOD_DIR4
	DDRIO99NB1	C10	SERVMOD_DIR5
	DDRIO99PB1	C9	SERVMOD_DIR6

* Careful with pin swapping: the P nets of the differential pairs 0, 1, 17 and 18 are connected to clock-capable pins and can't be swapped with the other I/Os.



Project/Equipment		DI/OT	
Document		Designer C. Gentsos	
BE/CO		Drawn by C. Gentsos	
CERN		Check by *	
DI/OT Rad-tol System Board		Last Mod. C. Gentsos	
FPGA I/O Banks B1, B2		File FPGA_Banks_1_2.SchDoc	
Print Date 28/09/2020 12:23:28		Sheet 7 of 17	
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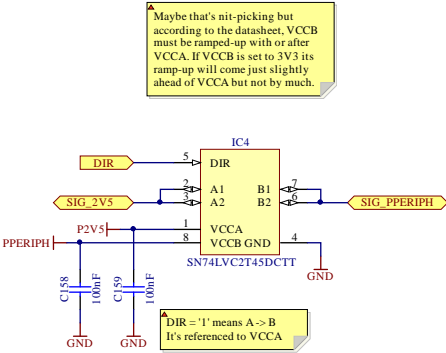
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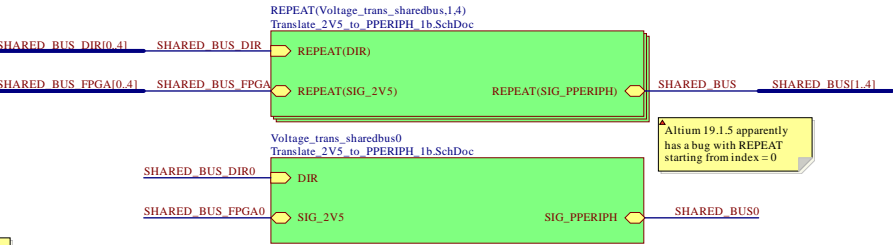
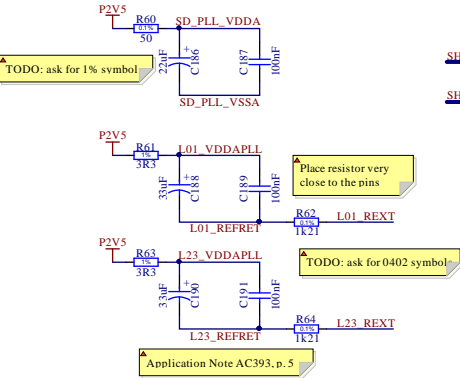
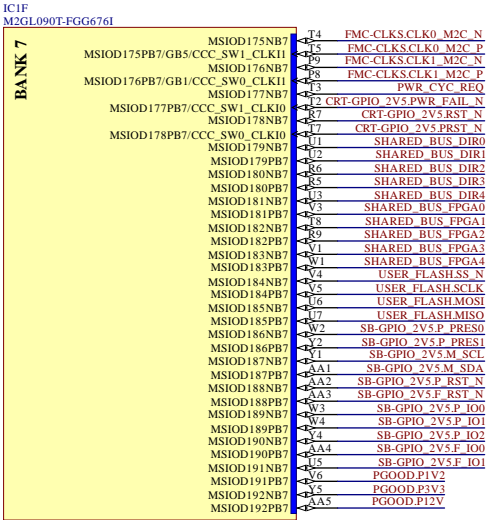
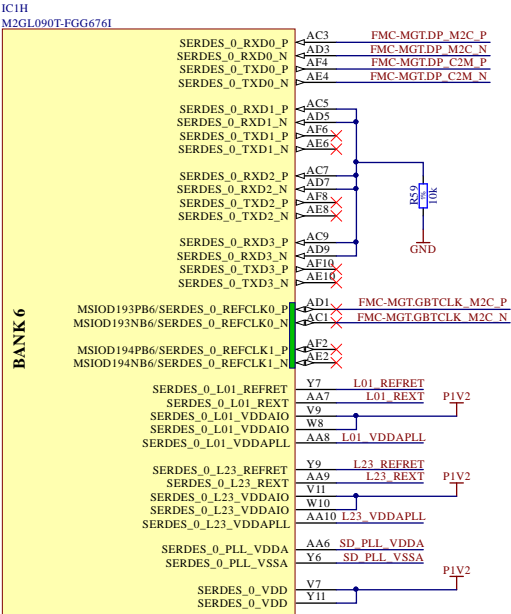
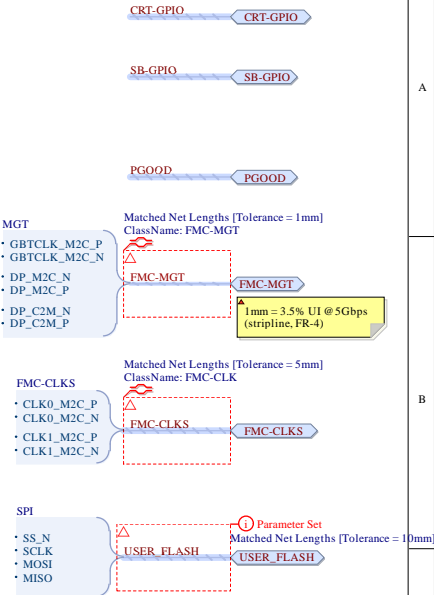
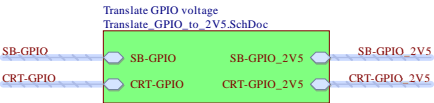
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Banks powered by 2.5V



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		File FPGA_Banks_6_7.SchDoc	
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		Sheet 9 of 17	
		A3 *	

DI/OT Rad-tol System Board
FPGA I/O Banks B6, B7

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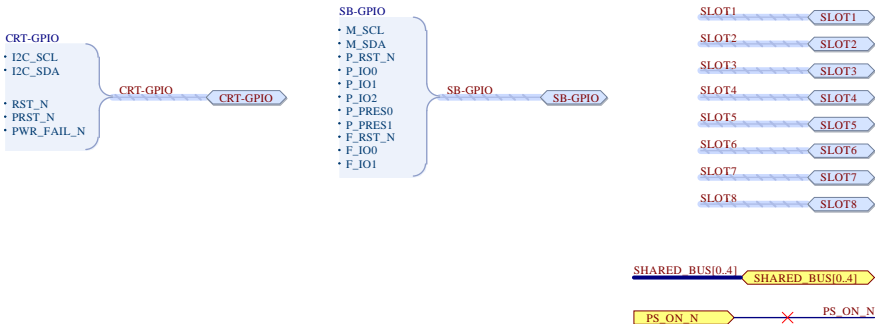
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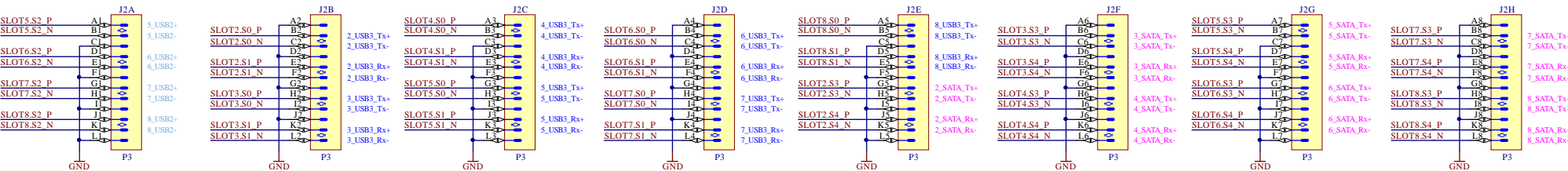
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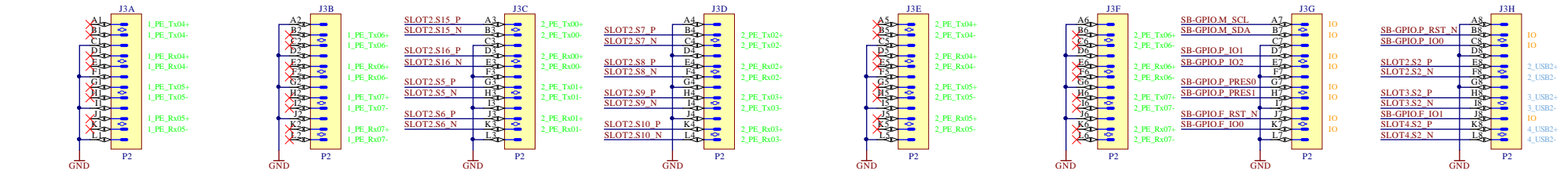
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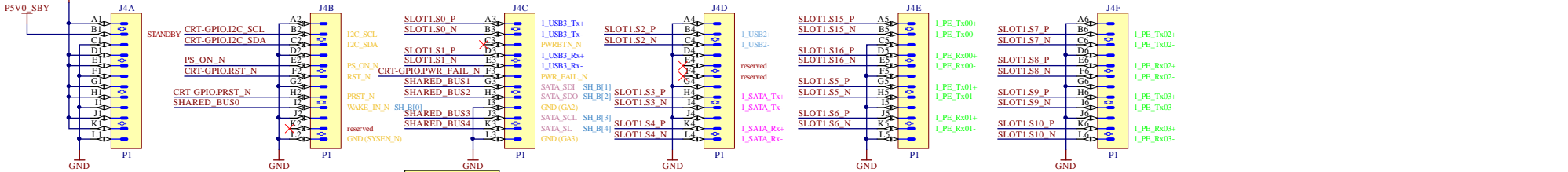
P3 Connector



P2 Connector



P1 Connector



TODO: how to handle PWRBTN?

n_{PE} PE_Tx00 and n_{PE} PE_Rx00 diff pairs can carry Multi-Gigabit signals (2.1.6). 1000Ohm impedance, 5mm tolerance

Project/Equipment		DIOT	
Document		Designer	C. Gentsos
		Drawn by	C. Gentsos
		Check by	*
		Last Mod.	C. Gentsos
		File	CPCL-S_Backplane_P1-P3_SchDoc
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		Sheet	11 of 17
		Size	A3
		Scale	*

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DIOT Rad-tol System Board
CPCL-S Backplane (1/2)

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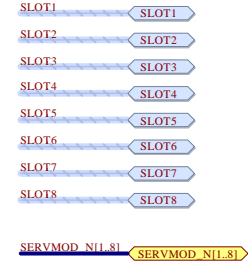
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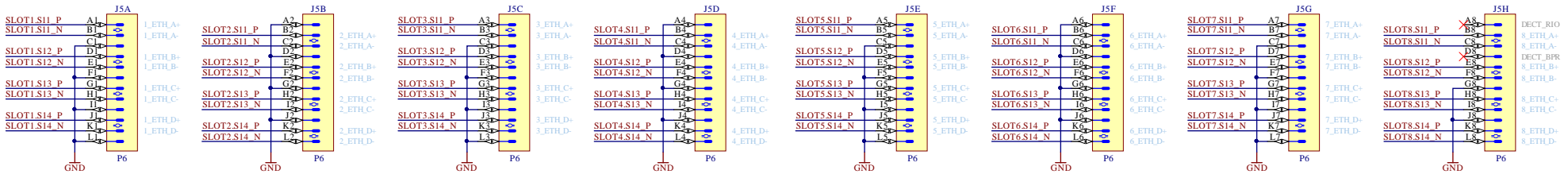
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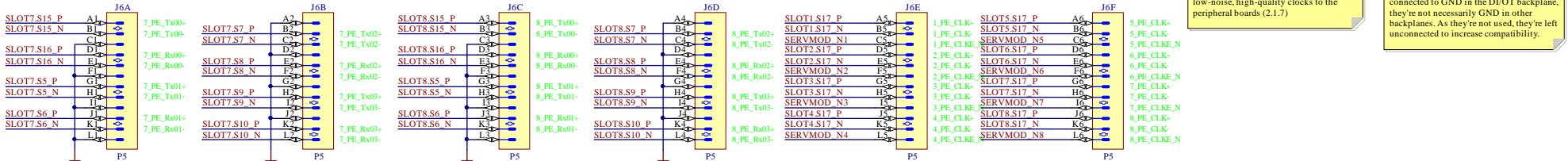
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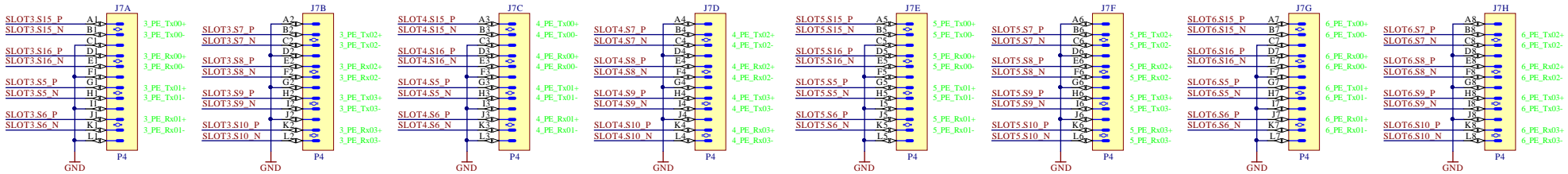
P6 Connector



P5 Connector



P4 Connector



1. PE_CLK diff pairs will provide low-noise, high-quality clocks to the peripheral boards (2.1.7)

The DECT_RIO and DECT_BPR pins are connected to GND in the DIOT backplane, they're not necessarily GND in other backplanes. As they're not used, they're left unconnected to increase compatibility.

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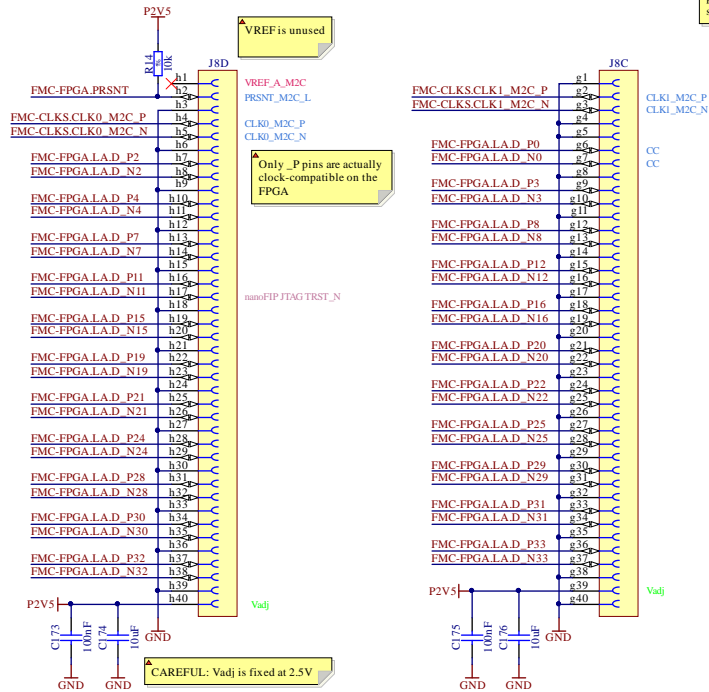
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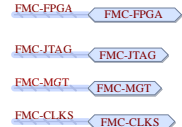
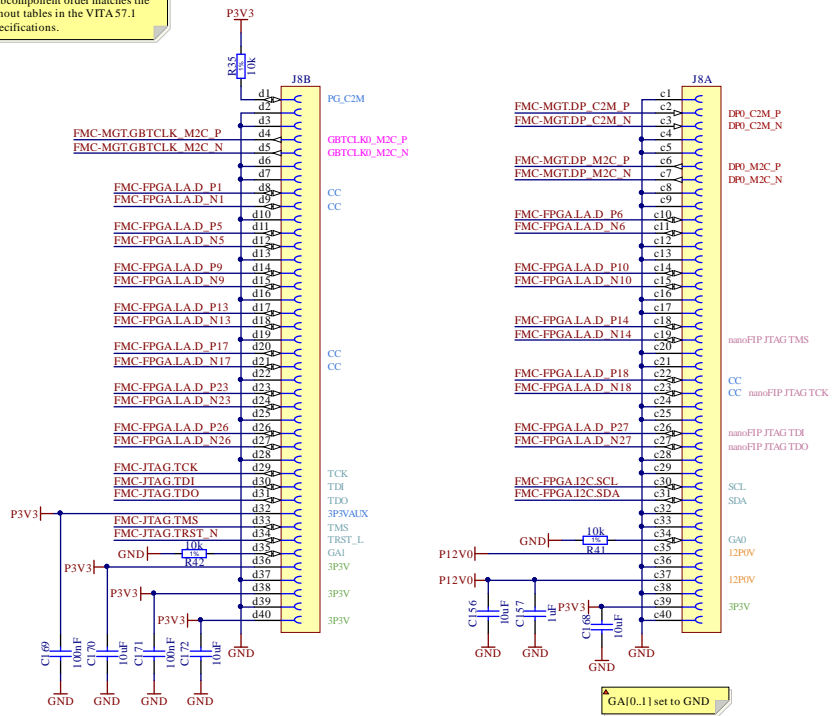
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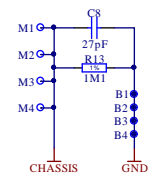
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Subcomponent order matches the pinout tables in the VITA 57.1 specifications.



Front panel and FMC slot spacers



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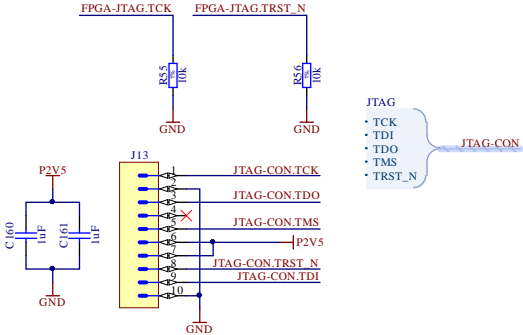
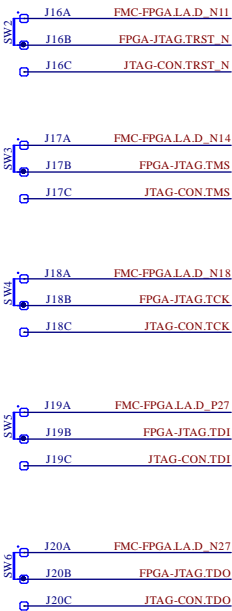
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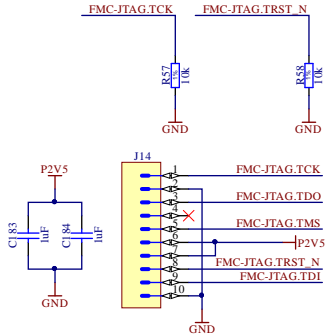
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In the Igloo2 evaluation board they use HTST-105-01-L-DV-A but there doesn't seem to be any difference.



Don't confuse this with the nanoFIP JTAG, this is just to provide an easily accessible JTAG connector to program the FMC card

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DI/OT Rad-tol System Board
JTAG Chains

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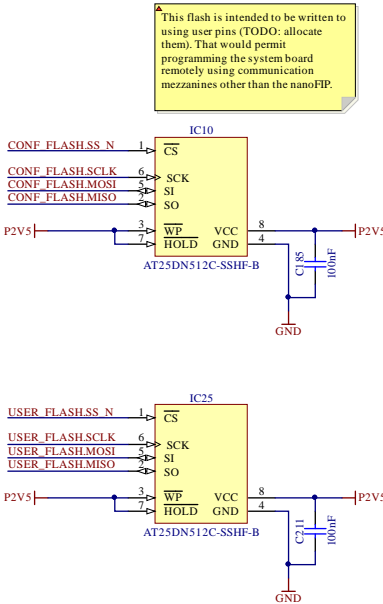
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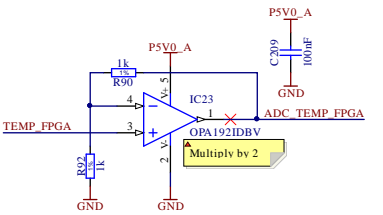
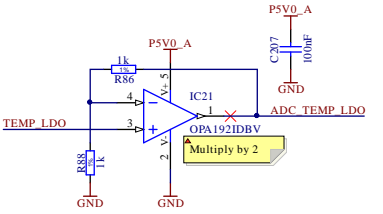
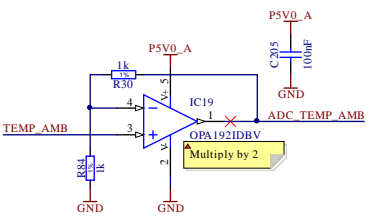
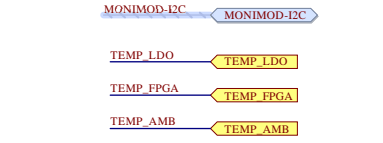
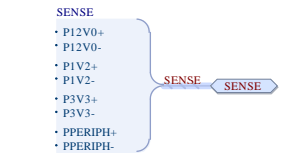
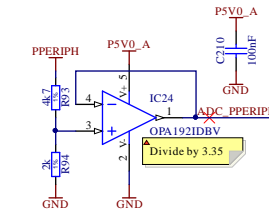
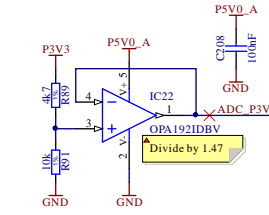
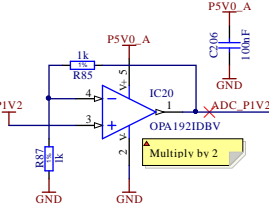
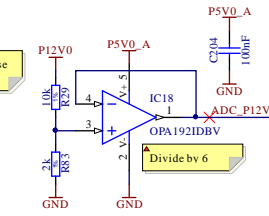
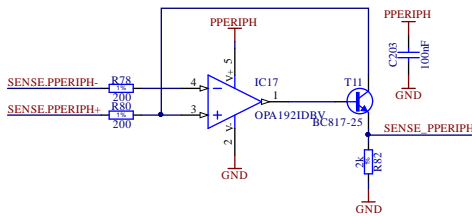
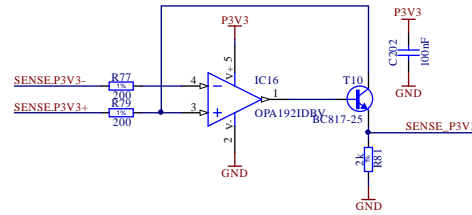
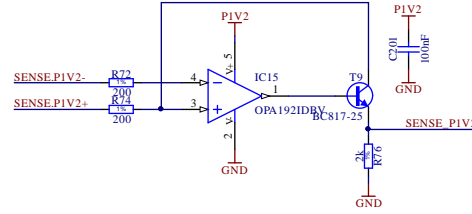
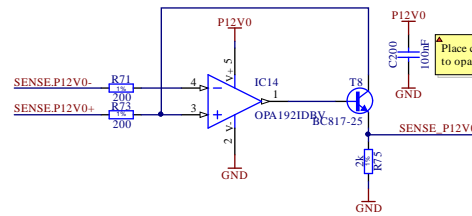
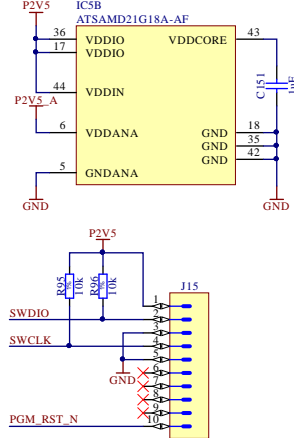
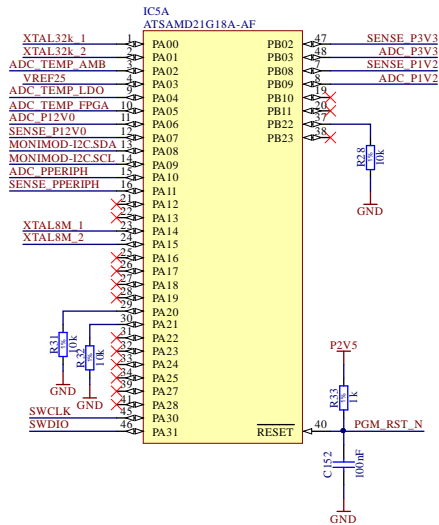
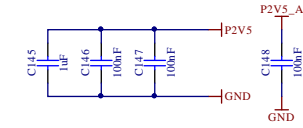
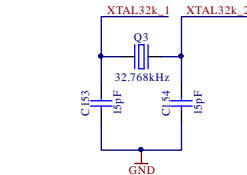
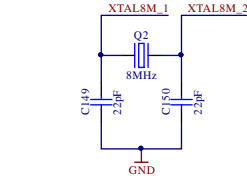
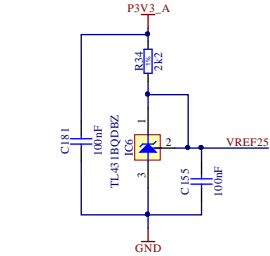
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DI/OT Rad-tol System Board Monitoring

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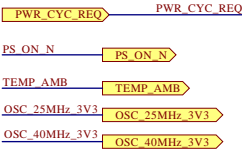
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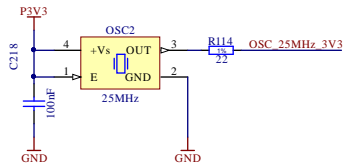
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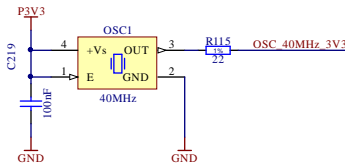


TODO: We have the pins, do we want to double the clocks in case someone likes redundancy?

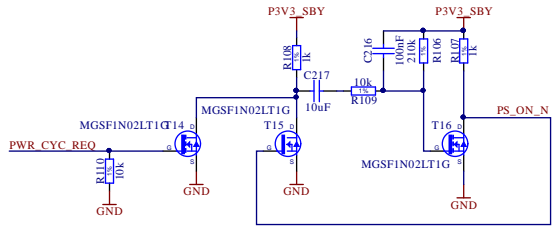
25MHz oscillator



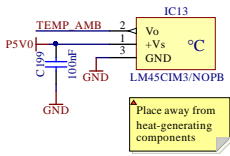
40MHz oscillator



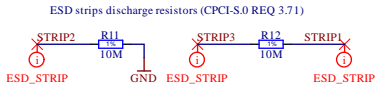
Power cycle pulse generator



Ambient temp sensor



ESD Protection



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DI/OT Rad-tol System Board
Miscellaneous

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